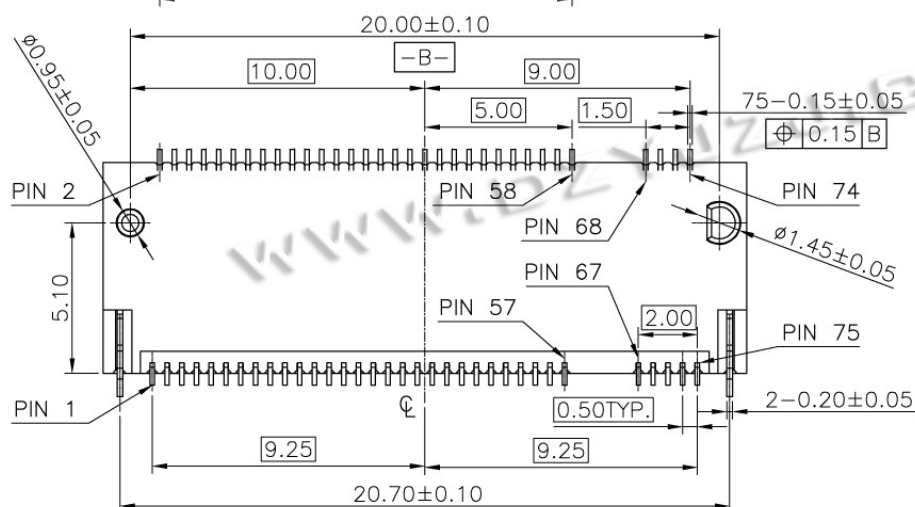
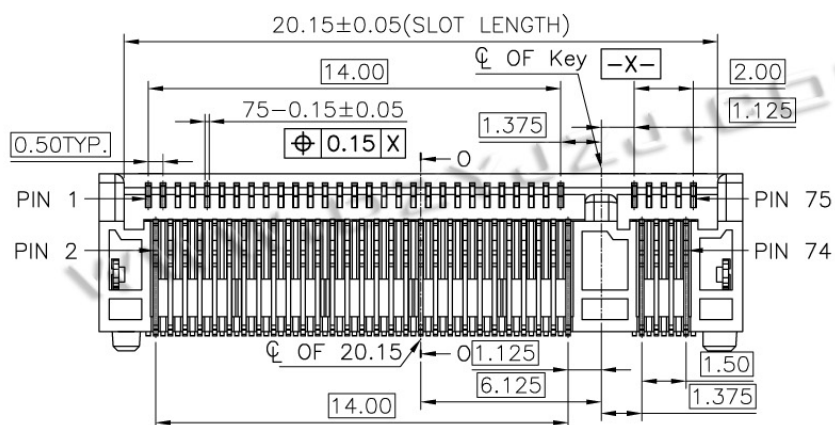
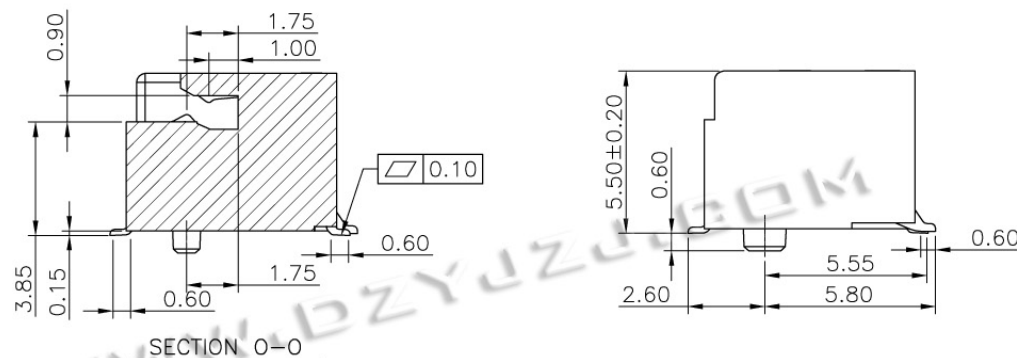
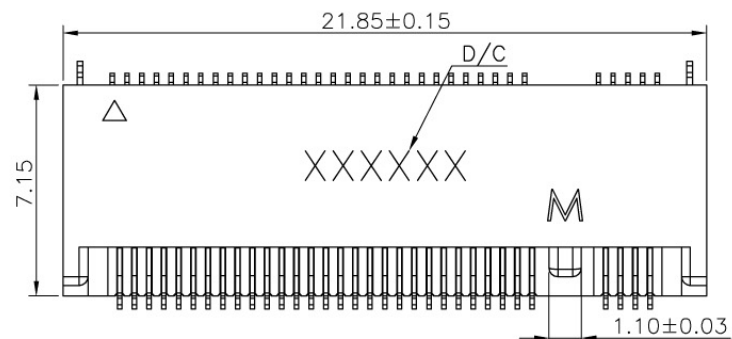
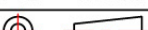
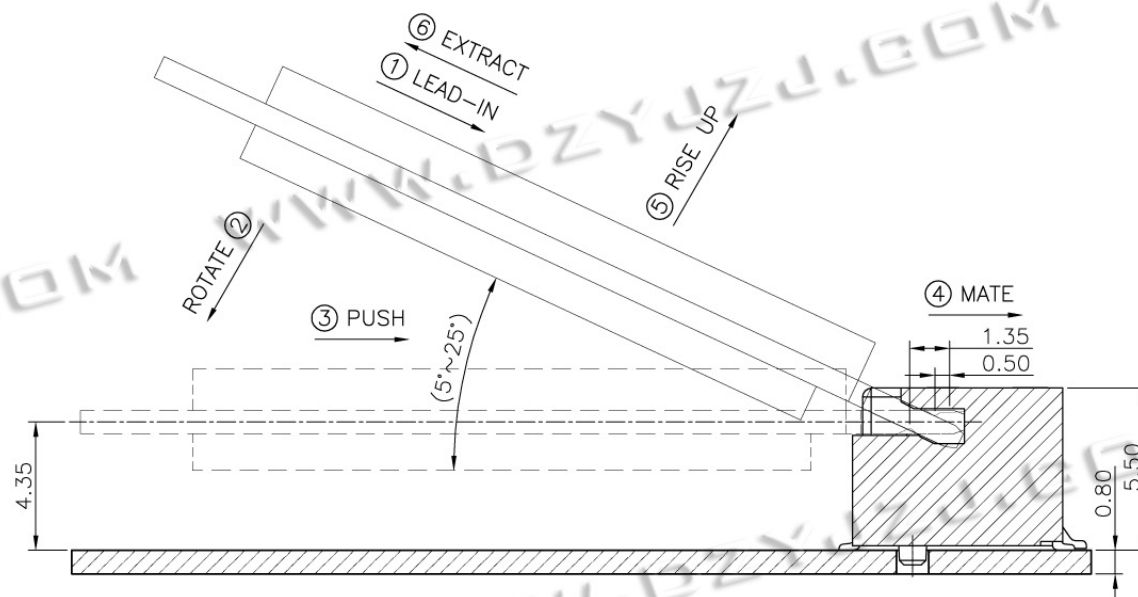
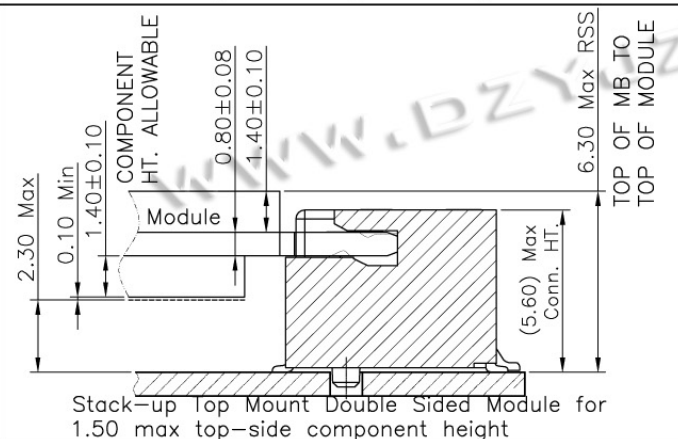
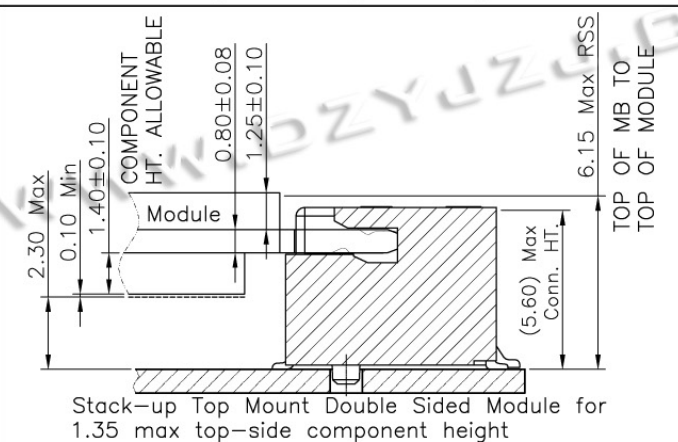
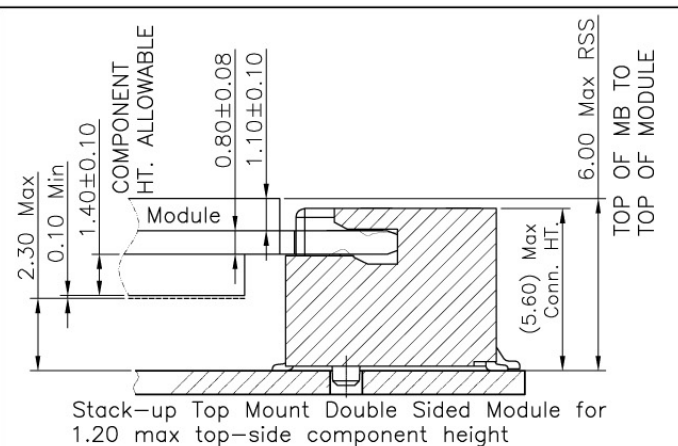




- THE TEMPERATURE SHALL BE 260°C MAINTAINING 10 SECONDS.

		深圳市华宇创精密电子有限公司			
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X* ±2* X.X* ±0.5*		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.5MM PITCH M.2 H5.5 (KEY M)	
 UNIT: mm [inch]		CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC17M-05NGFF-550
		APPROVED BY: 柯南	DATE : 2014-02-23	MOLD NO.	
SCALE:1:1	SIZE: A4		DRAW NO:	HYC-1903071621	
			SHEET NO.	1 OF 1	

Assembly stack height schematic diagram



HOW TO MATE AND EXTRACT

MATE: ① → ④

EXTRACT: ⑤ → ⑥

NOTE: Mating force will generate from step 3 to step 4.



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.5MM PITCH M.2 H5.5 (KEY M)	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC17M-05NGFF-550
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 柯南	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	HYC-1903071621
			SHEET NO.	1 OF 1

